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**Bib Data Sheet**

**CONFIRMATION NO. 2851**

| SERIAL NUMBER 09/766,814 | FILING DATE 01/22/2001 RULE | CLASS 257 29 | GROUP ART UNIT 3729 2814 2871 | ATTORNEY DOCKET NO. TESSERA 3.0-115 CONT CIP |
|---|---|---|---|---|

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** CONTINUING DATA **************************** *Yes NOT*

THIS APPLICATION IS A CIP OF 09/520,320 03/07/2000, *now U.S. Patent 6,486,003*
WHICH IS A CON OF 08/988,097 12/10/1997 ABN
WHICH CLAIMS BENEFIT OF 60/032,870 12/13/1996
THIS APPLICATION 09/766,814.
IS A CIP OF 09/271,688 03/18/1999, *U.S. Patent 6,429,112*
WHICH CLAIMS BENEFIT OF 60/032,870 12/13/1996
AND A CIP OF 09/138,858 08/24/1998 PAT 6,104,087
WHICH IS A DIV OF 08/440,665 05/15/1995 PAT 5,801,441
WHICH IS A DIV OF 08/271,768 07/07/1994 PAT 5,518,964
AND SAID 09/271,688 03/18/1999
IS A CIP OF 08/712,855 09/12/1996 PAT 6,191,368
WHICH CLAIMS BENEFIT OF 60/003,619 09/12/1995
AND SAID 09/271,688 03/18/1999
IS A CIP OF 09/057,125 04/08/1998 PAT 5,959,354
WHICH IS A DIV OF 08/678,808 07/12/1996 PAT 5,830,782

** FOREIGN APPLICATIONS ********************** *NONE NOT*

**IF REQUIRED, FOREIGN FILING LICENSE GRANTED**
** 04/02/2001

| Foreign Priority claimed ☐ yes ☒ no 35 USC 119 (a-d) conditions met ☐ yes ☒ no ☐ Met after Allowance Verified and Acknowledged _____ Examiner's Signature   Initials | STATE OR COUNTRY WA | SHEETS DRAWING 16 | TOTAL CLAIMS 74 22 | INDEPENDENT CLAIMS 8 3 |
|---|---|---|---|---|

**ADDRESS**
00530

**TITLE**

Microelectronic packages having deformed bonded leads and methods therefor

| FILING FEE RECEIVED | FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT | ☐ All Fees |
|---|---|---|
| | | ☐ 1.16 Fees ( Filing ) |
| | | ☐ 1.17 Fees ( Processing Ext. of time ) |